

N-Channel 60V (D-S) Power MOSFET

Features

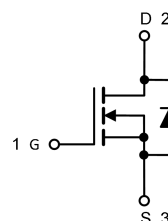
- 100% Avalanche Tested
- Extremely Low Losses with Low FOM $R_{DS(on)} \cdot Q_g$
- Halogen Free, Pb-Free
- RoHS Compliant



TO-252 (D-PAK)

Applications

- DC/DC
- Motors, lamps
- Power switching



Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain Source Voltage	V_{DS}	60	V
Gate Source Voltage	V_{GS}	± 20	V
Drain Current, Continuous $V_{GS}=10\text{V}$ (Note 1)	I_D	80	A
Drain Current, Pulsed (Note 2)	I_{DM}	320	A
Single Avalanche Energy@ $L=0.5\text{mH}$	E_{AS}	210	mJ
Power Dissipation (Note 3)	P_D	74	W
Operating Junction/ Storage Temperature Range	T_J / T_{STG}	-55 to +150	$^\circ\text{C}$

Note 1: Calculated continuous current based on maximum allowable junction temperature.

Note 2: Repetitive rating; pulse width limited by max. junction temperature.

Thermal Characteristics

Parameter	Symbol	Max	Unit
Thermal Resistance Junction to Case (Note 3)	R_{thJC}	1.7	$^\circ\text{C/W}$

Note 3: The power dissipation P_D is based on max. junction temperature, using junction-to-case thermal resistance

Electrical Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	60	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	--	--	1	uA
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =250uA	2	--	4	V
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Drain-Source On-state Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	--	6.3	8	mΩ
Total Gate Charge	Q _g	I _D = 20A, V _{DS} =30V, V _{GS} = 10V	--	70	--	nC
Gate-Source Charge	Q _{gs}		--	15	--	
Gate-Drain Charge	Q _{gd}		--	22	--	
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DD} =30V, R _{GEN} =3Ω, I _D = 30A	--	15	--	ns
Turn-on Rise Time	t _r		--	22	--	
Turn-off Delay Time	t _{d(off)}		--	40	--	
Turn-off Fall Time	t _f		--	8.6	--	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =60V, f=1MHz	--	3450	--	pF
Output Capacitance	C _{oss}		--	180	--	
Reverse Transfer Capacitance	C _{rss}		--	165	--	

Reverse Diode Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	I _S	T _C =25°C	--	--	80	A
Pulsed Source Current (Body Diode)	I _{SM}		--	--	320	
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V	--	--	1.2	V
Reverse Recovery Time	T _{rr}	I _F = 20A, di/dt = 100 A/μs	--	25	--	ns
Reverse Recovery Charge	Q _{rr}		--	30	--	nC

Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 - Typical Output Characteristics

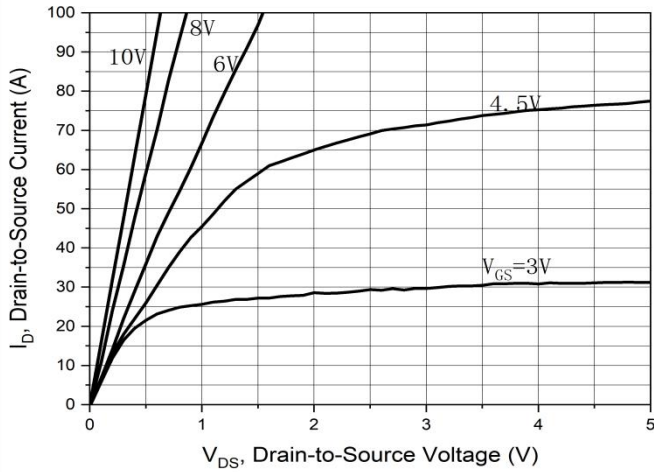


Fig.2 - Drain-to-Source Breakdown Voltage vs. Junction Temperature

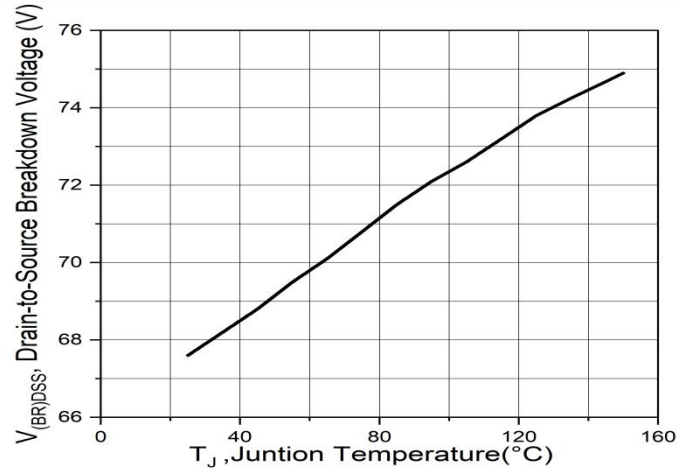


Fig.3 - R_DS(on) vs. Junction Temperature

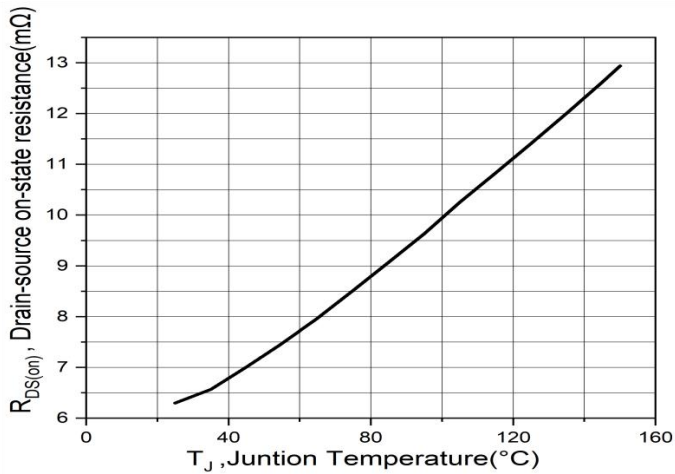


Fig.4 - V_th vs. Junction Temperature

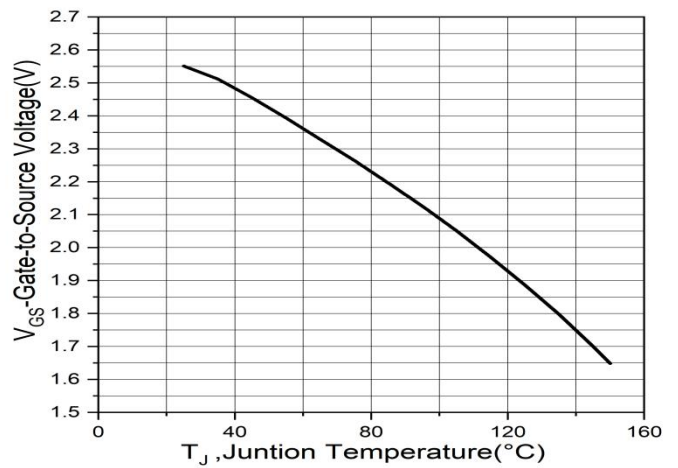


Fig.5 - Capacitance

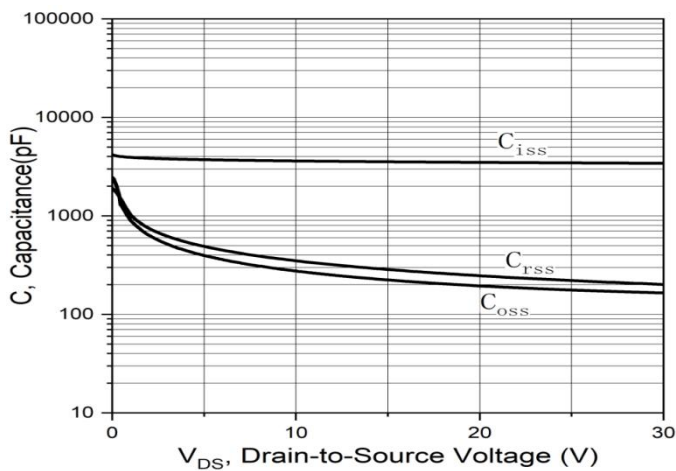
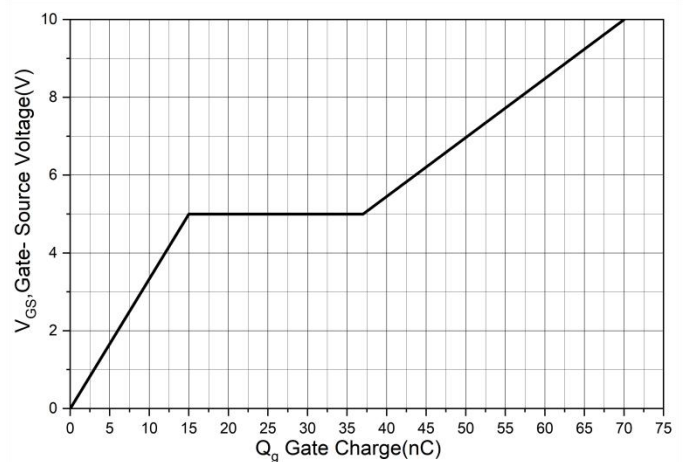


Fig.6 - Gate Charge



Typical Characteristics Curves ($T_J = 25^{\circ}\text{C}$ unless otherwise noted)

Fig.7 - Transfer Characteristics

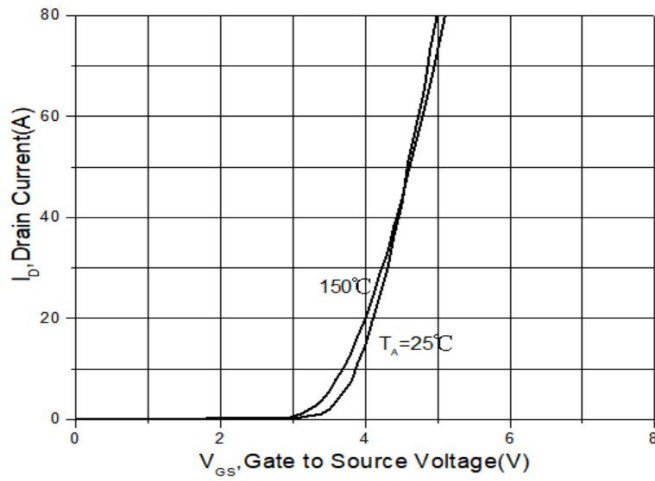
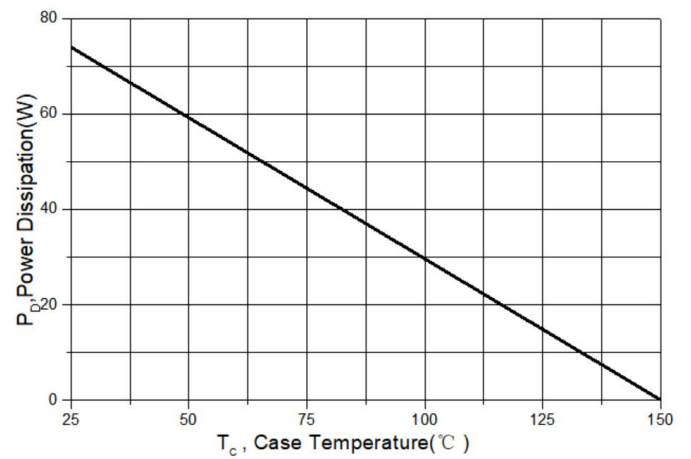
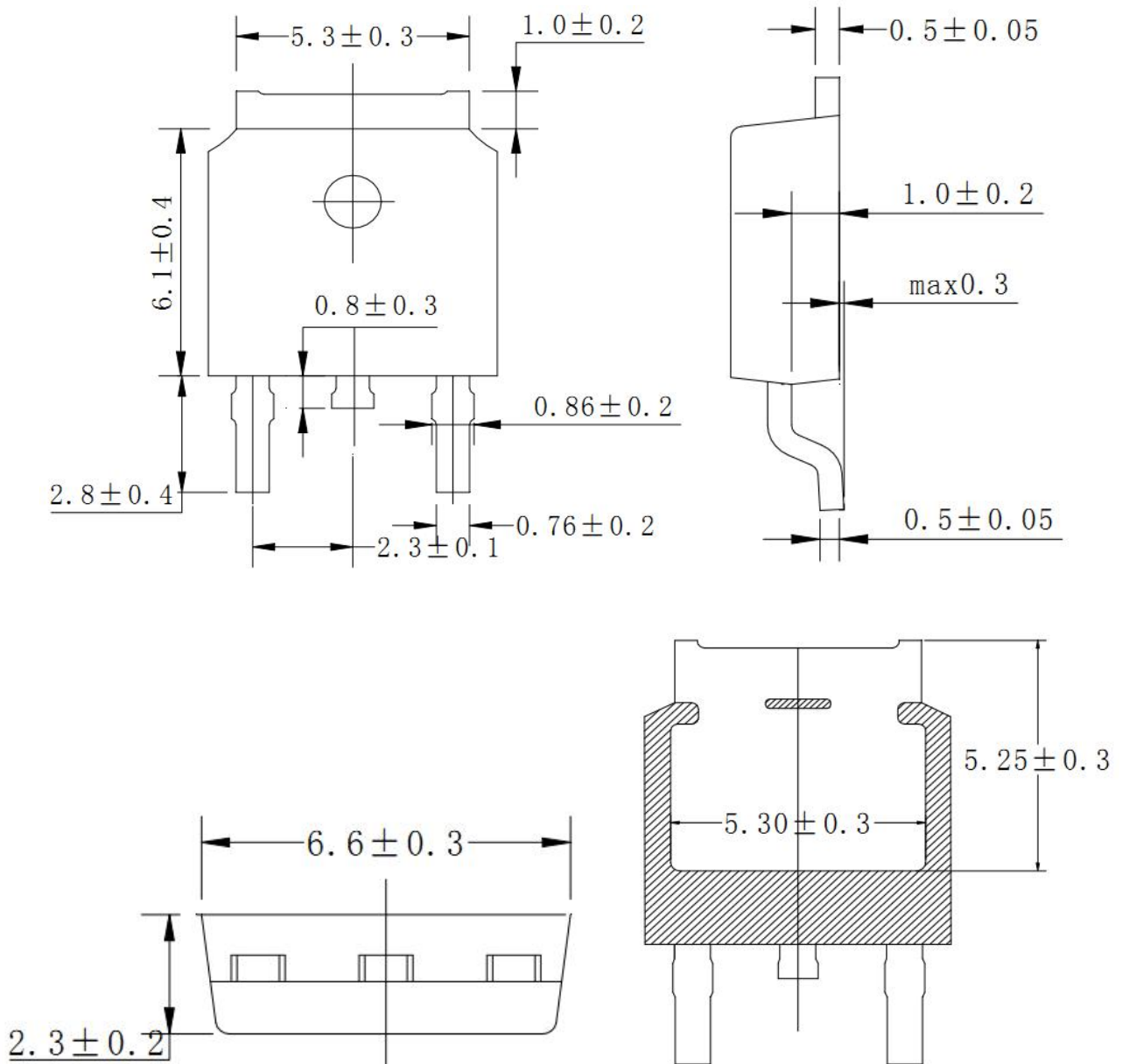


Fig.8 - Power Dissipation

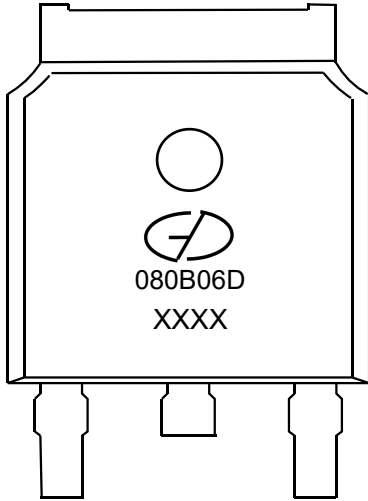


Package Outline Dimensions (Unit: millimeters)


TO-252(D-PAK)



Marking Outline



Part Name: GMN080B06D

1. Logo Mark: 
2. P/N Mark: 080B06D
3. Date Code: XXXX

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